

HP Intel Pentium G3260 processor 3.3 GHz 3 MB L3

Brand: HP Product code: 820587-001

Product name: Intel Pentium G3260

Intel Pentium G3260, 3M Cache, 3.3 GHz, 5 GT/s DMI2

HP Intel Pentium G3260 processor 3.3 GHz 3 MB L3:

Options, accessories, services and support for all your HP and Compaq products. HP Intel Pentium G3260. Processor family: Intel Pentium G, Processor socket: LGA 1150 (Socket H3), Processor lithography: 22 nm. Memory channels: Dual-channel, Maximum internal memory supported by processor: 32 GB, Memory types supported by processor: DDR3-SDRAM, DDR3L. On-board graphics card model: Intel® HD Graphics, Maximum on-board graphics card memory: 1.7 GB, On-board graphics card outputs supported: DVI, DisplayPort, Embedded DisplayPort (eDP), HDMI, VGA (D-Sub). Market segment: Desktop, PCI Express configurations: 1x16, 1x8+2x4, 2x8, Supported instruction sets: SSE4.1, SSE4.2. Compatibility: ProDesk 400 G2.5 ProDesk 400 G2 280 G1 ProDesk 600 G1

Processor		Graphics	
Processor model *	G3260	On-board graphics card refresh rate at maximum resolution	60 Hz
Processor base frequency *	3.3 GHz	(DisplayPort)	00 112
Processor family *	Intel Pentium G	On-board graphics card refresh rate	
Processor cores *	2	at maximum resolution (eDP -	60 Hz
Processor socket *	LGA 1150 (Socket H3) PC	Integrated Flat Panel) On board graphics card refresh rate	
Component for Processor lithography *	22 nm	On-board graphics card refresh rate at maximum resolution (HDMI)	60 Hz
Processor series	Intel Pentium G3000 series for Desktop	On-board graphics card refresh rate at maximum resolution (VGA)	60 Hz
Processor threads	2	Features	
System bus rate	5 GT/s	Execute Disable Bit	✓
Processor operating modes *	64-bit		•
Processor cache	3 MB	Idle States	•
Processor cache type	L3	Thermal Monitoring Technologies	
Thermal Design Power (TDP)	53 W	Market segment	Desktop
Stepping	C0	Maximum number of PCI Express lanes	16
Bus type	DMI2	PCI Express slots version	3.0
Memory bandwidth supported by processor (max)	21.3 GB/s	PCI Express configurations	1x16, 1x8+2x4, 2x8
		Supported instruction sets	SSE4.1, SSE4.2
Memory		Scalability	15
Maximum internal memory			
supported by processor	32 GB	CPU configuration (max)	1
supported by processor Memory types supported by	32 GB DDR3-SDRAM, DDR3L	Embedded options available	×
supported by processor Memory types supported by processor		Embedded options available Graphics & IMC lithography	x 22 nm
supported by processor Memory types supported by		Embedded options available Graphics & IMC lithography Thermal solution specification	×
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by	DDR3-SDRAM, DDR3L	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features	X 22 nm PCG 2013C
supported by processor Memory types supported by processor Memory clock speeds supported by processor	DDR3-SDRAM, DDR3L	Embedded options available Graphics & IMC lithography Thermal solution specification	x 22 nm
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology	X 22 nm PCG 2013C
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor Memory channels *	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V Dual-channel	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology (Intel® HT Technology)	x 22 nm PCG 2013C
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor Memory channels * ECC	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V Dual-channel	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology (Intel® HT Technology) Intel® Turbo Boost Technology Intel® AES New Instructions (Intel® AES-NI) Enhanced Intel SpeedStep	x 22 nm PCG 2013C
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor Memory channels * ECC Graphics	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V Dual-channel	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology (Intel® HT Technology) Intel® Turbo Boost Technology Intel® AES New Instructions (Intel® AES-NI) Enhanced Intel SpeedStep Technology	x 22 nm PCG 2013C x x
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor Memory channels * ECC Graphics On-board graphics card * On-board graphics card model * Maximum on-board graphics card	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V Dual-channel Intel® HD Graphics	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology (Intel® HT Technology) Intel® Turbo Boost Technology Intel® AES New Instructions (Intel® AES-NI) Enhanced Intel SpeedStep Technology Intel Trusted Execution Technology	x 22 nm PCG 2013C x x
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor Memory channels * ECC Graphics On-board graphics card * On-board graphics card model *	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V Dual-channel Intel® HD Graphics 1.7 GB	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology (Intel® HT Technology) Intel® Turbo Boost Technology Intel® AES New Instructions (Intel® AES-NI) Enhanced Intel SpeedStep Technology Intel Trusted Execution Technology Intel VT-x with Extended Page	x 22 nm PCG 2013C x x
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor Memory channels * ECC Graphics On-board graphics card * On-board graphics card model * Maximum on-board graphics card memory On-board graphics card outputs	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V Dual-channel Intel® HD Graphics 1.7 GB DVI, DisplayPort, Embedded	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology (Intel® HT Technology) Intel® Turbo Boost Technology Intel® AES New Instructions (Intel® AES-NI) Enhanced Intel SpeedStep Technology Intel Trusted Execution Technology Intel VT-x with Extended Page Tables (EPT)	x 22 nm PCG 2013C x x
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor Memory channels * ECC Graphics On-board graphics card * On-board graphics card model * Maximum on-board graphics card memory	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V Dual-channel Intel® HD Graphics 1.7 GB	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology (Intel® HT Technology) Intel® Turbo Boost Technology Intel® AES New Instructions (Intel® AES-NI) Enhanced Intel SpeedStep Technology Intel Trusted Execution Technology Intel VT-x with Extended Page Tables (EPT) Intel® Secure Key	x 22 nm PCG 2013C x x x x /
supported by processor Memory types supported by processor Memory clock speeds supported by processor Memory voltage supported by processor Memory channels * ECC Graphics On-board graphics card * On-board graphics card model * Maximum on-board graphics card memory On-board graphics card outputs	DDR3-SDRAM, DDR3L 1333 MHz 1.5 V Dual-channel Intel® HD Graphics 1.7 GB DVI, DisplayPort, Embedded DisplayPort (eDP), HDMI, VGA (D-	Embedded options available Graphics & IMC lithography Thermal solution specification Processor special features Intel® Hyper Threading Technology (Intel® HT Technology) Intel® Turbo Boost Technology Intel® AES New Instructions (Intel® AES-NI) Enhanced Intel SpeedStep Technology Intel Trusted Execution Technology Intel VT-x with Extended Page Tables (EPT)	x 22 nm PCG 2013C x x x x x x x

Graphics		Processor special features	
On-board graphics card dynamic frequency (max)	1100 MHz	Intel 64	✓
Number of displays supported (on- board graphics)	3	Intel Virtualization Technology (VT-x)	✓
On-board graphics card DirectX	11.1/12	Intel Virtualization Technology for Directed I/O (VT-d)	×
version		Conflict-Free processor	✓
On-board graphics card OpenGL version	4.3	Intel® vPro™ Platform Eligibility	×
On-board graphics card maximum resolution (DisplayPort)	2560 x 1600 pixels	Operational conditions	
On-board graphics card maximum		Tcase	72 °C
resolution (eDP - Integrated Flat Panel)	2560 x 1600 pixels	Other features	
On-board graphics card maximum resolution (HDMI)	1920 x 1080 pixels	Compatibility	ProDesk 400 G2.5 ProDesk 400 G2 280 G1 ProDesk 600 G1
On-board graphics card maximum resolution (VGA)	1920 x 1200 pixels		

